

Preliminary

CUSTOMER : _____.

DATE : 2012. 07. 05.

SPECIFICATIONS FOR APPROVAL

3535 Ceramic PKG

MODEL NAME : LEMWA33X80MW00

APPROVAL	REMARK	APPENDIX

Designed	Checked	Approved

SPECIFICATION

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Change History of Revision

[illegible]

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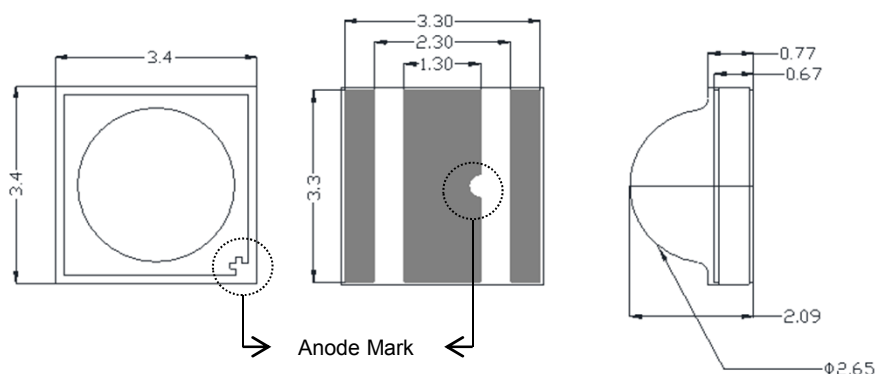
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1. Features

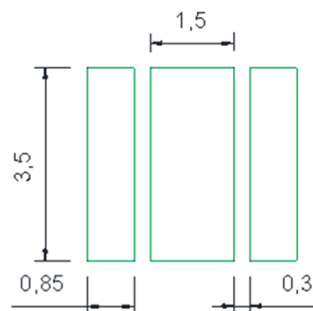
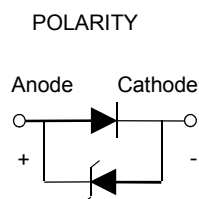
- Lighting Color : Warm White
- Ceramic PKG Type : 3.4× 3.4× 2.09 mm (L× W× H)
- Viewing Angle : 112°
- Thermal Resistance (Rthj-s) : 6 °C/W
- Chip Material : InGaN
- Soldering Methods : IR reflow soldering
- ESD Withstand Voltage : Up to 2kV according to JESD22-A 114-B

2. Outline Dimensions

(unit : mm)



Recommendable soldering pattern
(For reflow soldering)



▪ Tolerances Unless Dimension $\pm 0.13\text{mm}$

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3. Applications

- Interior and Exterior Illumination, Automotive Lighting

4. Absolute Maximum Ratings

(T_a=25℃)

Items	Symbols	Ratings	Unit
Forward Current ^{*1)}	I _F	1,500	mA
Pulse Forward Current ^{*2)}	I _{FP}	1,500	mA
Power Dissipation	P _D	5,325	mW
Operating Temperature	T _{opr}	-40 ~ 85	℃
Storage Temperature	T _{stg}	-40 ~ 100	℃
Junction Temperature ^{*3)}	T _J	150	℃
ESD		2	KV

*1) T_s=60℃ (@T_a=25℃)

*2) T_a=25℃

*3) I_F=1A, T_s=120℃ (@T_a=85℃)

5. Electro - Optical Characteristics

(T_a=25℃)

Items	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	I _F =350mA	2.9	3.0	3.2	V
Reverse Voltage (Zener Diode) ^{*1)}	V _R	I _F =350mA	-	-	6.5	V
Luminous Flux	Φ _V	I _F =350mA	87	100	114	lm
Luminous Intensity	I _V	I _F =350mA	30	35	40	cd
CIE Value	X / Y	I _F =350mA	Refer to '6. Rank Sorting Method'			-
Viewing Angle	2Θ1/2	I _F =350mA	-	112	-	deg
Color Rendering Index	R _a	I _F =350mA	80	-	-	-
Typical Temperature Coefficient of Forward Voltage	ΔV _F /ΔT _J	I _F =350mA	-1.0	-	-4.0	mV/℃
Thermal resistance	R _{thJ-S}	I _F =350mA	-	6	-	℃/W

*1) The value is based on performance of Zener Diode.

*2) Measured between T_J=25~100℃, at I_F=350mA

※ These values measured by Optical Spectrum Analyzer of LG Innotek Co., LTD and tolerances are followings as below

- Luminous Flux (Φ_V) : ± 10%, Forward Voltage(V_F) : ± 0.1, CIE Value : ± 0.005, CRI Value : ± 3, Viewing Angle : ± 5°

※ All PKG are tested by LG Innotek equipment. But, the values of characteristics of PKG could be changed slightly depend on the Test Equipment.

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5. Electro - Optical Characteristics

If (mA)	Vf (V)	Power (W)	Flux (lm)	lm/W
350	2.98	1.043	100	95.9
700	3.19	2.219	175	78.9
1000	3.31	3.310	227	68.6
1500	3.50	5.250	302	57.5

* lm values are representative references only.

6. Rank Sorting Method

▪ Rank of Luminous Flux (@ 350mA)

Rank	Φ (lm, @ 350mA)		
	Min	Typ	Max
W2	87	90.5	94
W3	94	97	100
X1	100	103.5	107
X2	107	110.5	114

▪ Rank of Forward Voltage (@ 350mA)

Rank	V _F (V, @ 350mA)		
	Min	Typ	Max
0	2.9	-	3.0
1	3.0	-	3.1
2	3.1	-	3.2

▪ Rank of CRI (@ 350mA)

Rank	Ra (CRI, @ 350mA)		
	Min	Typ	Max
80	80	-	-

Rank name method : Please refer to the following example

Rank Name : X1 - 1 - M11

Φ_V Rank = X1, V_F Rank = 1, CIE Rank = M11

* This categories are established for classification of products.

▪ Rank of CIE Value (@ 350mA)

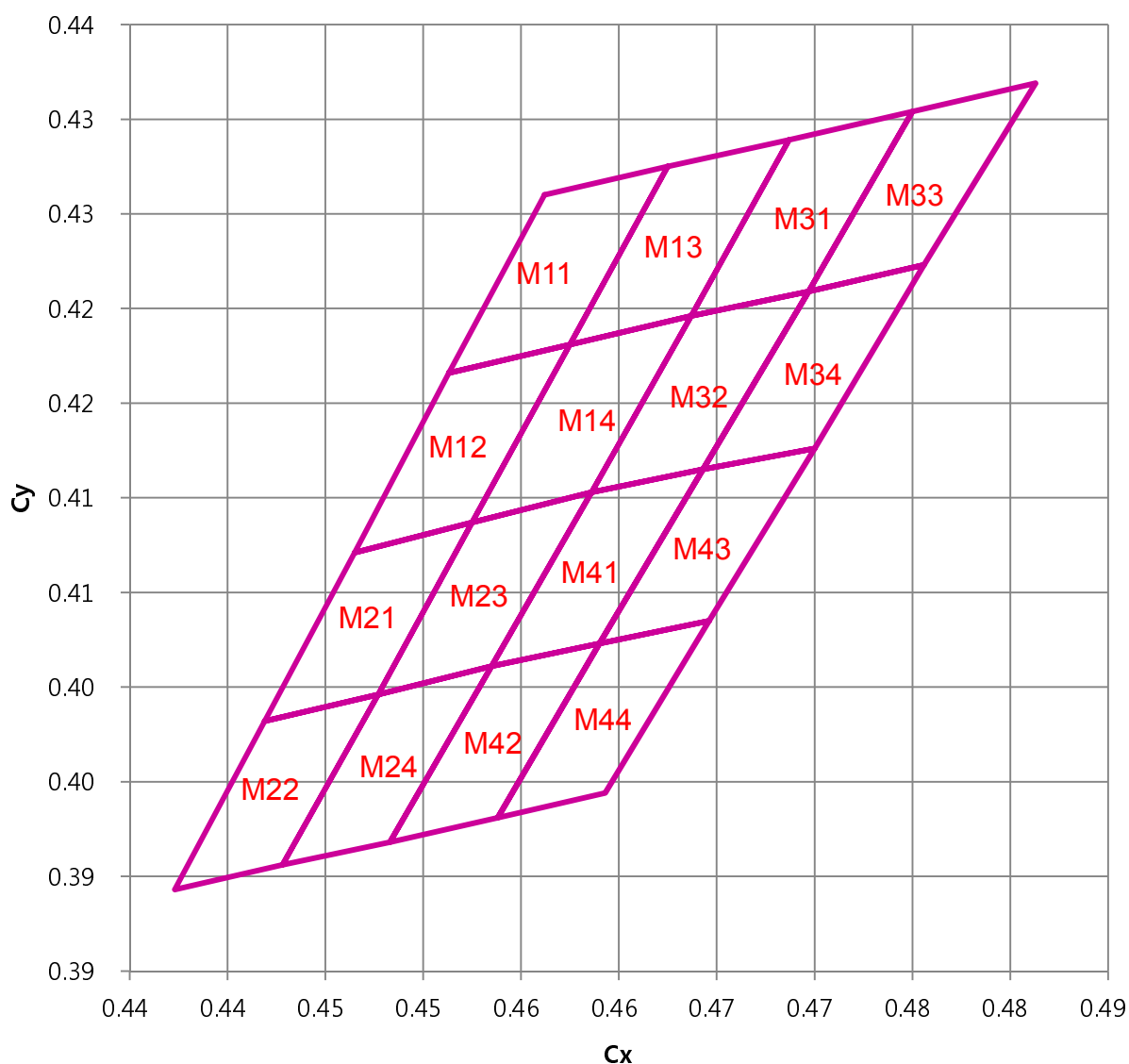
-. CCT : 2700K (2725K± 145K)

Rank	CIE X	CIE Y	Rank	CIE X	CIE Y
M11	0.4562	0.4260	M31	0.4687	0.4289
	0.4625	0.4275		0.4750	0.4304
	0.4575	0.4181		0.4697	0.4209
	0.4513	0.4166		0.4637	0.4196
M12	0.4513	0.4166	M32	0.4637	0.4196
	0.4575	0.4181		0.4697	0.4209
	0.4525	0.4087		0.4643	0.4115
	0.4465	0.4071		0.4586	0.4103
M13	0.4625	0.4275	M33	0.4750	0.4304
	0.4687	0.4289		0.4813	0.4319
	0.4637	0.4196		0.4756	0.4223
	0.4575	0.4181		0.4697	0.4209
M14	0.4575	0.4181	M34	0.4697	0.4209
	0.4637	0.4196		0.4756	0.4223
	0.4586	0.4103		0.4700	0.4126
	0.4525	0.4087		0.4643	0.4115
M21	0.4465	0.4071	M41	0.4586	0.4103
	0.4525	0.4087		0.4643	0.4115
	0.4477	0.3996		0.4590	0.4023
	0.4419	0.3982		0.4535	0.4011
M22	0.4419	0.3982	M42	0.4535	0.4011
	0.4477	0.3996		0.4590	0.4023
	0.4428	0.3906		0.4538	0.3931
	0.4373	0.3893		0.4483	0.3918
M23	0.4525	0.4087	M43	0.4643	0.4115
	0.4586	0.4103		0.4700	0.4126
	0.4535	0.4011		0.4646	0.4035
	0.4477	0.3996		0.4590	0.4023
M24	0.4477	0.3996	M44	0.4590	0.4023
	0.4535	0.4011		0.4646	0.4035
	0.4483	0.3918		0.4593	0.3944
	0.4428	0.3906		0.4538	0.3931

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Chromaticity Diagram



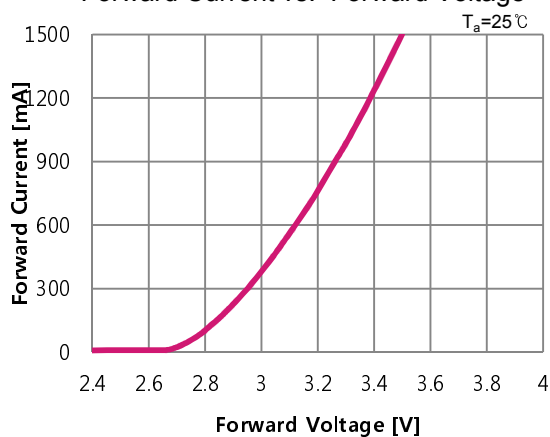
- Chromaticity coordinate groups are tested at a current pulse duration of 10 ms and a tolerance of ± 0.005 .
- This categories are established for classification of products.
- Color Coordinate is based on the CIE 1931 Chromaticity Diagram

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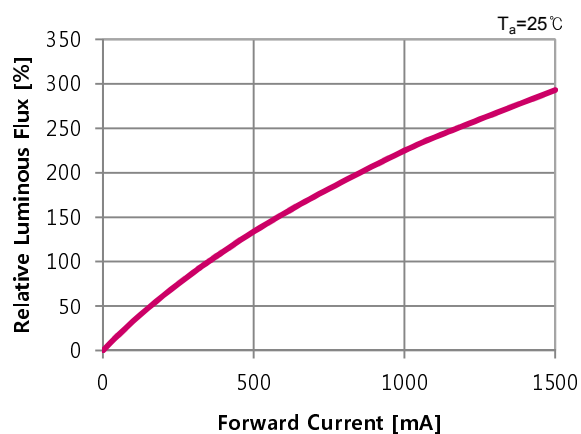
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7. Typical Characteristic Curves

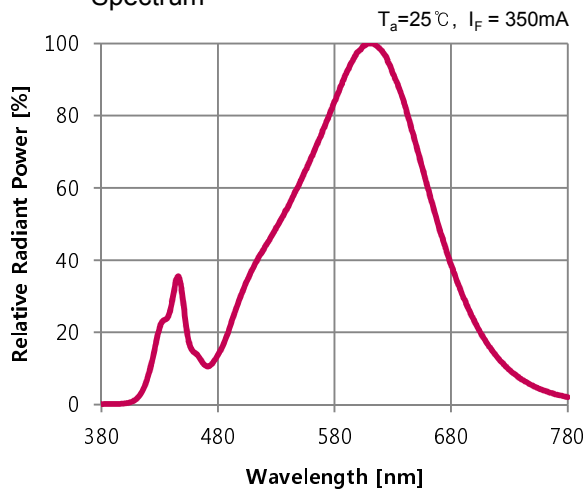
■ Forward Current vs. Forward Voltage



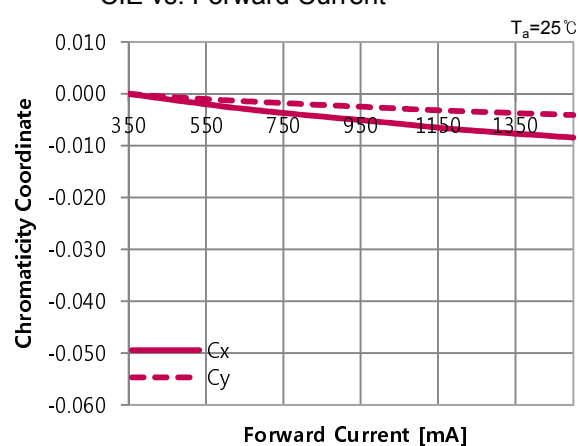
■ Relative Luminous Flux vs. Forward Current



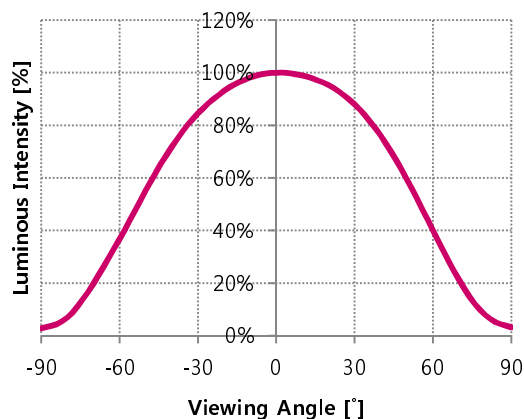
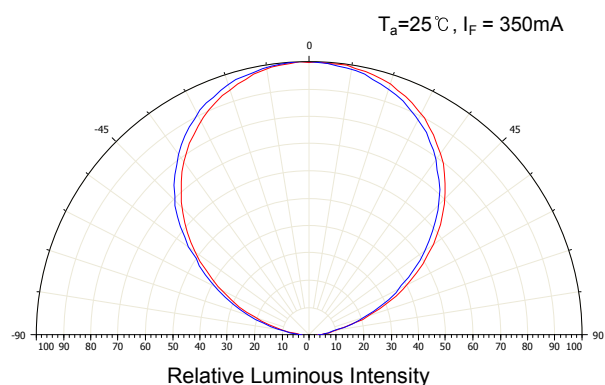
■ Spectrum



■ CIE vs. Forward Current



■ Radiation Characteristics

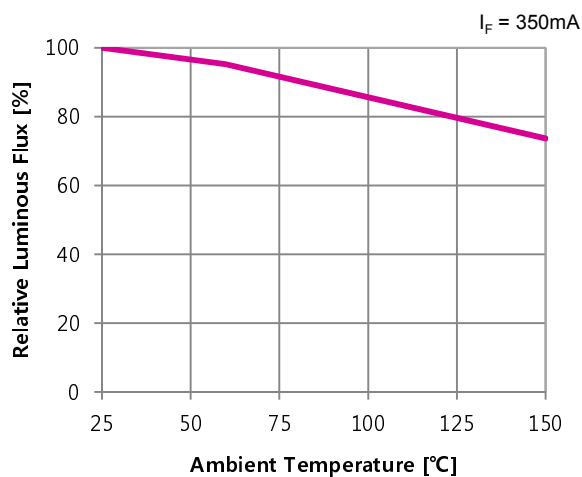


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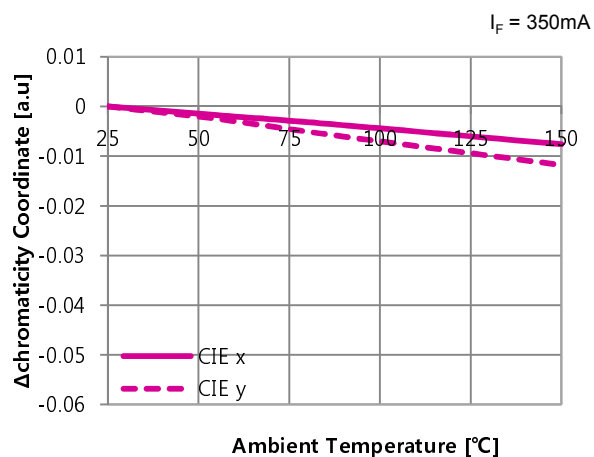
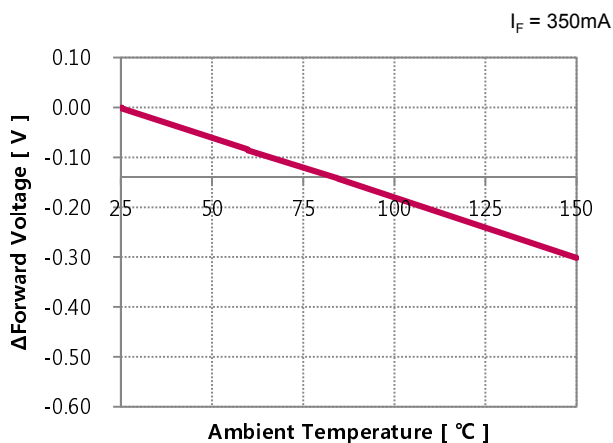
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7. Typical Characteristic Curves

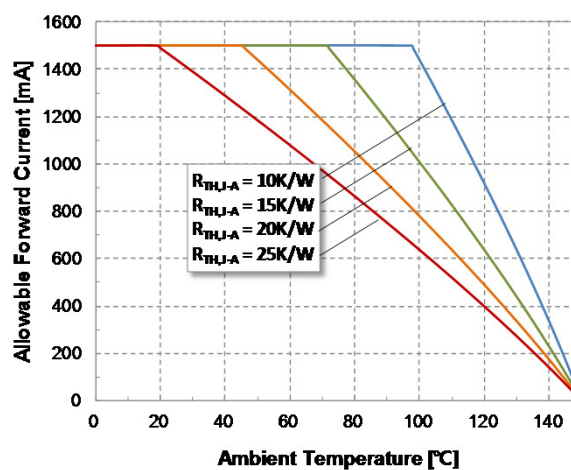
▪ Luminous Flux vs. Ambient Temp.



▪ CIE vs. Ambient Temp.

▪ ΔV_F vs. Ambient Temp.

▪ Derating Curve



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8. Reliability Test Items and Conditions

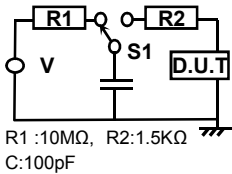
8-1.Criteria for Judging the Damage

Item	Symbol	Test Condition	Limit	
			Min	Max
Forward Voltage	V_F	$I_F = 350\text{mA}$	-	U.S.L. $\times 1.3$
Luminous Flux	Φ_V	$I_F = 350\text{mA}$	$S \times 0.7$	-

*U.S.L : Upper Spec Limit, *L.S.L : Lower Spec Limit *S : Initial Value

※ The Reliability criteria of ESD Test is judged by V_F shift ($\pm 0.2\text{V}@8\text{mA}$) or impedance(Ω) check data.

8-2. Item and Results of Reliability Test

No	Item	Test Condition	Test Hours/ Cycles	Sample No	Ac/Re
1	Steady State Operating Life	$T_a=25^\circ\text{C}$, $I_F=1500\text{ [mA]}$	1000hr	11 pcs	0 / 1
2	High Temp. Humidity Life	$T_a=85^\circ\text{C}$, 85% RH, $I_F=1000\text{ [mA]}$	1000hr	11 pcs	0 / 1
3	Steady State Operating Life of High Temperature 1	$T_a=85^\circ\text{C}$, $I_F=1000\text{ [mA]}$	1000hr	11 pcs	0 / 1
4	Steady State Operating Life of Low Temperature	$T_a=-40^\circ\text{C}$, $I_F=1000\text{ [mA]}$	1000hr	11 pcs	0 / 1
5	High Temp. Storage	$T_a=100^\circ\text{C}$	1000hr	11 pcs	0 / 1
6	Low Temp. Storage	$T_a=-40^\circ\text{C}$	1000hr	11 pcs	0 / 1
7	Temperature Cycle	-40°C (30min) $\sim$ 25°C (5min) $\sim$ 100°C (30min) $\sim$ 25°C (5min)	100cycle	11 pcs	0 / 1
8	Thermal Shock	100°C (15min) $\sim$ 25°C (5min) $\sim$ -40°C (15min)	100cycle	11 pcs	0 / 1
9	Resistance to Soldering Heat (Reflow Soldering)	$T_{\text{sld}}=260^\circ\text{C}$, 10sec / 2times (Pre Treat. 30°C , 70%, 168hr)	2 times	11 pcs	0 / 1
10	Electrostatic Discharge (HBM, $\pm 2\text{kV}$)	 R1 :10MΩ, R2:1.5KΩ C:100pF	3times	11 pcs	0 / 1
11	Vibration	100~2000~100Hz sweep 4min, 200m/s ² , 3directions, 4cycles	48 min.	11 pcs	0 / 1

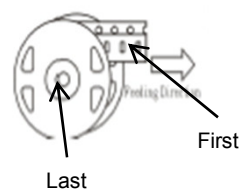
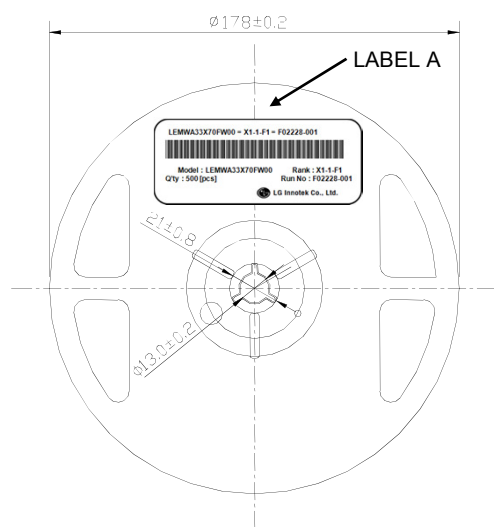
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9. Package and Marking of Products

9-1. Taping Outline Dimension

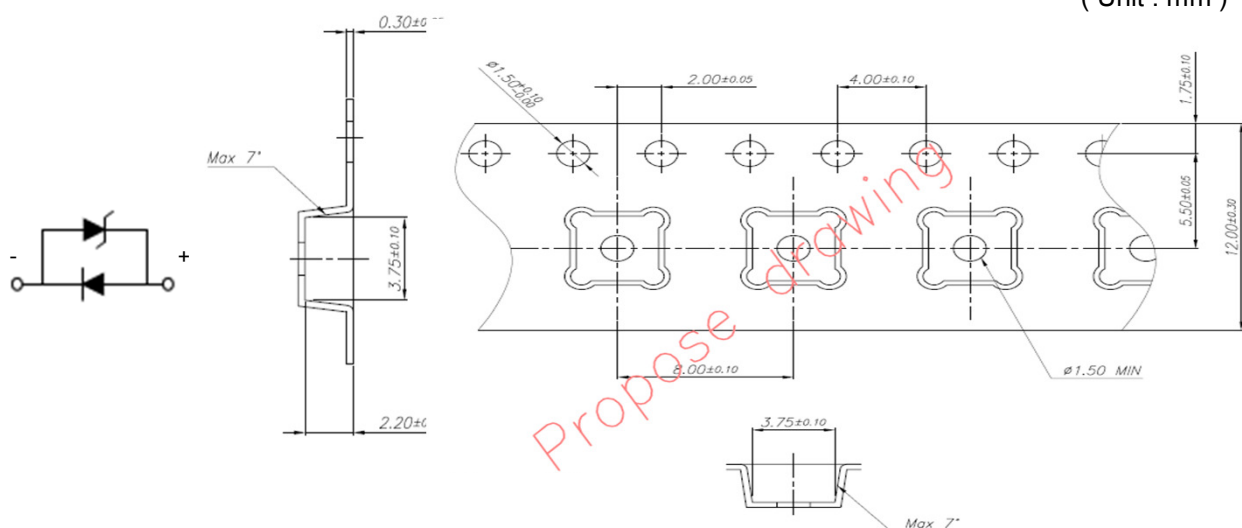
Dimension of Reel



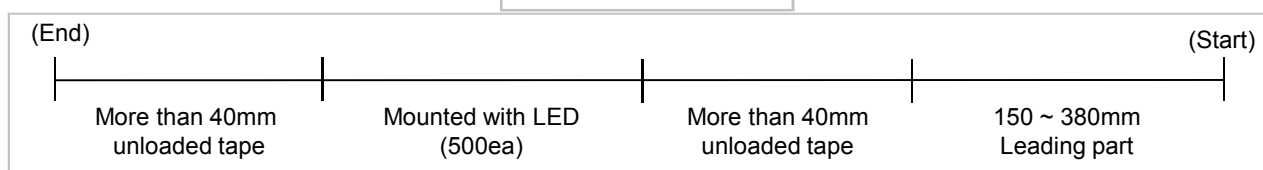
- ◆ Empty Reel Length
 - First : 55cm
 - Last : 38 cm

- ◆ Packing Materials :
- Reel : Conductive PS (black)
 - Emboss Tape : Conductive PS (black)
 - Cover Tap : Conductive PET base

Dimension of Tape



Arrangement of Tape

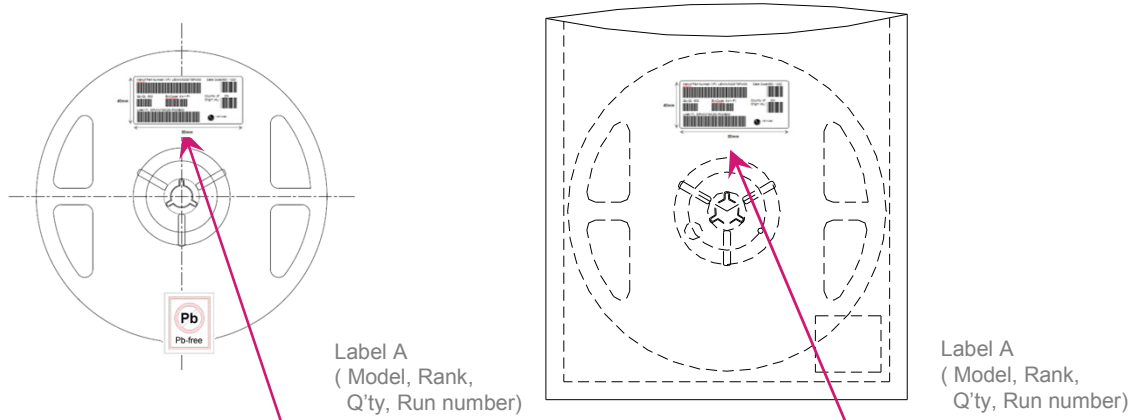


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9-2. Package

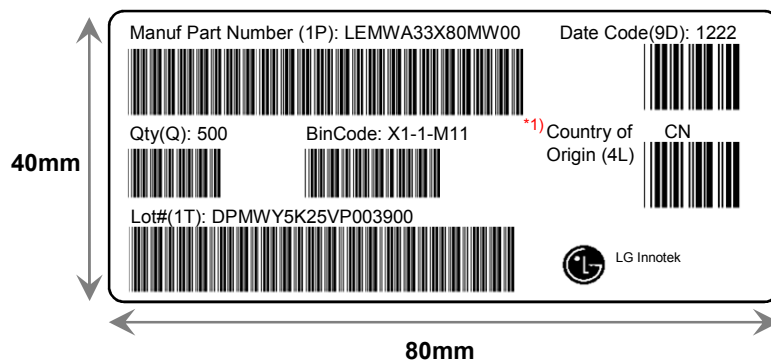
Products are packed in one bag of 500 pcs (one taping reel) and a label is affixed on each bag specifying Model, Rank, Quantity and Run number.



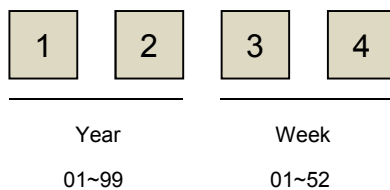
- Package : damp-proof package made of aluminum

※. Label A

Specifying Model Name, Rank, Rank, Quantity and Run number



▪ Date Code(9D)



▪ Lot#(1T)

LG innotek trace code

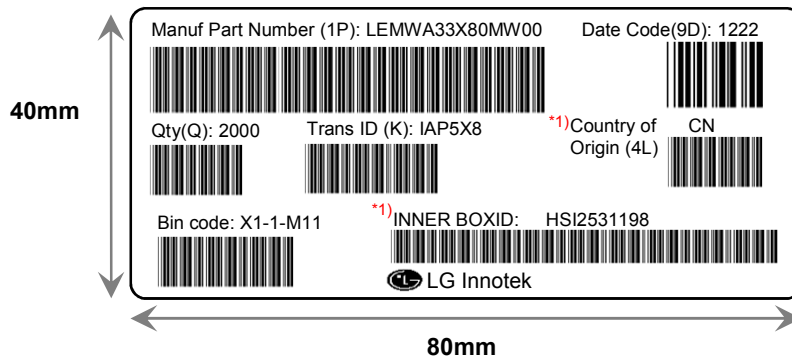
*1) contents on label can be changed depending on the production site

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※ Label B

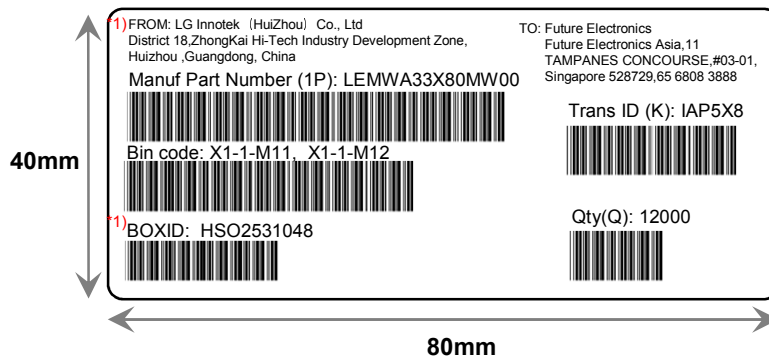
Specifying Customer, Date, Model Name, Quantity, Customer Part no, Outbox ID
, Rank/Rank Q'ty



※ Label C

*1) contents on label can be changed depending on the production site

Specifying Customer, Date, Model Name, Quantity, Customer Part no, Outbox ID
, Rank/Rank Q'ty



■ Box ID indication

1	2	3	4	5	6	7	8	9	10
Site	Code	Outbox	Year	Month	Date			Serial No	
Paju: P Huizhou: H	S, P	Outbox: O Inbox: I	12 : 2 13 : 3 14 : 4 15 : 5	1~9 : 1~9 10 : A 11 : B 12 : C	(01 ~ 31)			(001 ~ 999)	

■ Trans ID(K)

Future lighting trace code

*1) contents on label can be changed depending on the production site

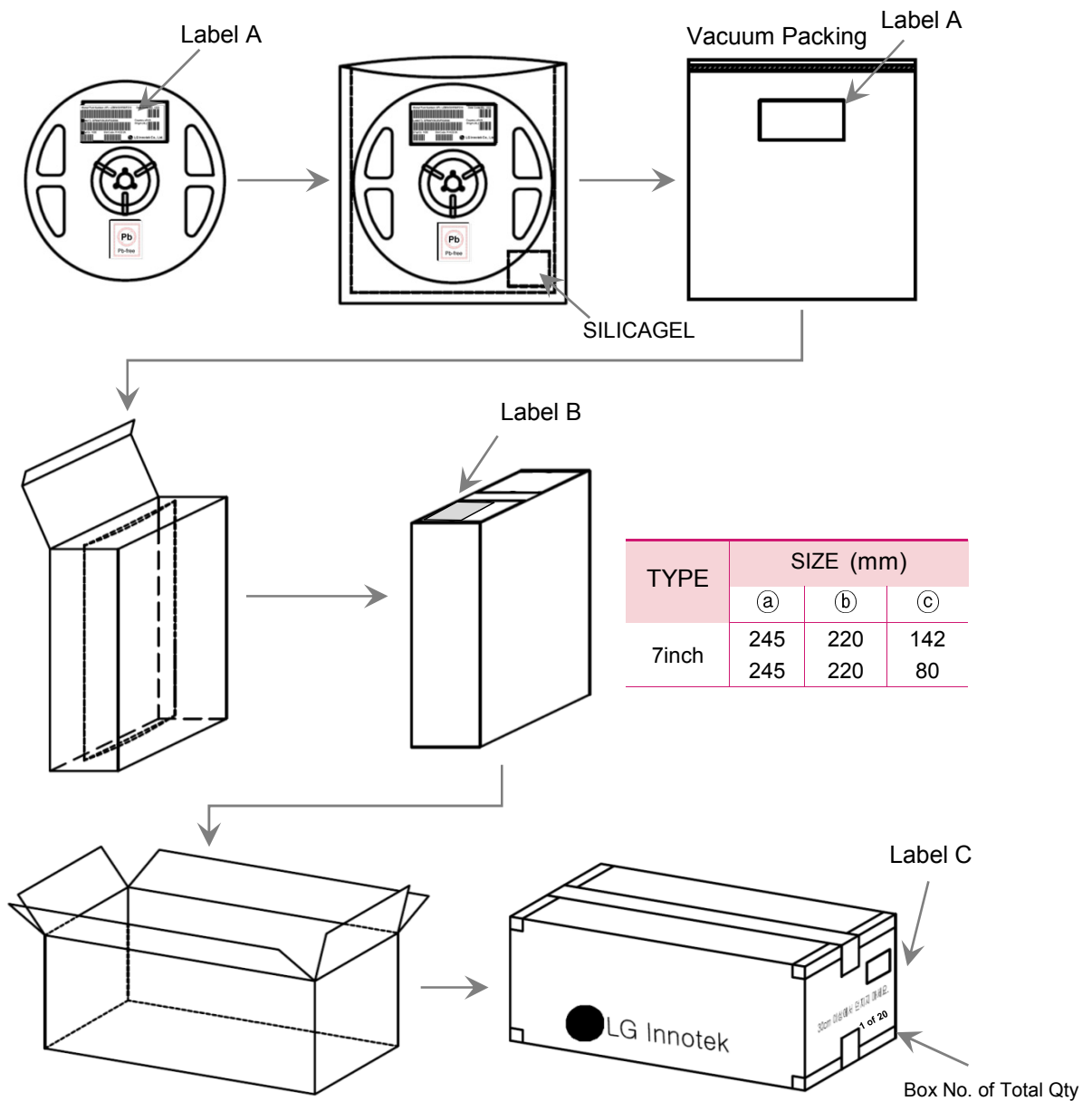
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9-3. Packing Specifications

Reeled products (numbers of products are 500pcs) packed in a seal off aluminum moisture-proof bag along with desiccants (Silica gel).

Four aluminum bags (total maximum number of products are 2,000 pcs) packed in an inner box and Six inner boxes are put into an outer box.



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10. Cautions on use

10-1. Moisture Proof Package

- When moisture is absorbed into the SMD package it may vaporize and expand during soldering.
- There is possibility that this can cause exfoliation of the contacts and damage the optical characteristics of the LEDs.

10-2. For the Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	$\leq 30^{\circ}\text{C}$	$\leq 90\%\text{RH}$	Within 1 Year from Delivery Date
	After Opening Aluminum Bag	$\leq 30^{\circ}\text{C}$	$\leq 70\%\text{RH}$	$\leq 168\text{hours}$
Baking		$65 \pm 5^{\circ}\text{C}$	-	$\geq 24\text{hours}$

Before opening the package

- Proper temperature and RH conditions for storage are : $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, less than 60% RH
- Do not open Moisture-Proof bag before the products are ready to use.

After opening the package

- Proper temperature and RH conditions for storage are : $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, less than 60% RH
- The LEDs should be soldered within 168 hours (7days) after opening the package.
- If unused LEDs remain, they should be stored in a moisture-proof bag with a absorbent Material. (ex. silica gel)
- If the Moisture absorbent material (ex. silica gel) loses its color or the LEDs have exceeded the storage time, baking treatment should be performed using the following condition.
Conditions for baking : $60 \pm 5^{\circ}\text{C}$, 20% RH and 24 hours maximum.

10-3. For the Usage

- LED PKG should not be used in directly exposed environment containing hazardous substances. (ex. Sulfur, Chlorine, Phthalate)
- The LEDs has silver plated metal parts. The silver plating become tarnished when being exposed to an environment which contains corrosive gases.
- After assembly and during use, silver plating can be affected by the corrosive gases emitted by components and materials in close proximity of the LEDs within an end product, and the gases entering into the product from the external atmosphere.
- Do not expose the LEDs to corrosive atmosphere during storage and using.
- Avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.
- In designed a circuit, the current through each LED must not exceed the absolute maximum rating

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10-4. Cleaning

- Please avoid using a brush for cleaning and do not wash the product in organic solvents such as acetone, Organic solvent (TCE, etc..) will damage the resin of the LEDs.
- It is recommended the IPA be used as a solvent for cleaning the LEDs. Please refer to following solvents and conditions.
Clearing Condition: Solvent : IPA, 25℃ max × 60 sec. max
- Do not clean the LEDs by the ultrasonic, When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition.
- Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

10-5. Heat Generation

- Thermal design of the end product is of paramount importance.
- Please consider the heat generation of the LED when making the system design.
- The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board as well as other component.
- It necessary to avoid intense heat generation and operate within the maximum ratings given in the specification.

10-6. Static Electricity

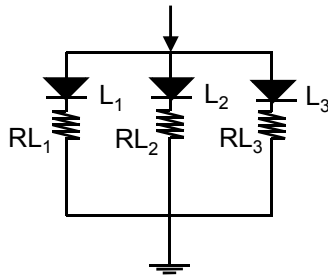
- If over-voltage, which exceeds the absolute maximum rating, is applied to the LEDs, it will damage the LEDs and result in destruction. Since the LEDs are sensitive to the static electricity and surge, it is strongly recommended to use a wristband or anti-electrostatic glove when handling the LEDs and all devices, equipment and machinery must be properly grounded.
- It is recommended that precautions be taken against surge voltage to the equipment the mounts the LEDs.
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the turn-on voltage becomes lower, or the LEDs do not light at the low current.
- When examining the final product, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. Static-damaged LEDs can easily be found by light-on test or the V_F test at a low current.

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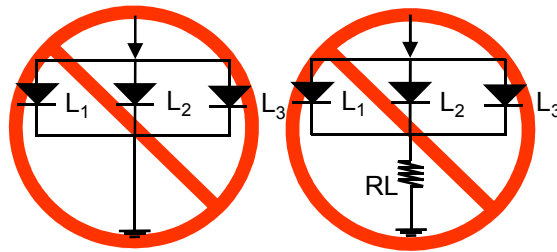
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10-7. Recommended Circuit

- In designed a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED.
- In general, the LEDs have a variation of forward voltage. Using LEDs with different forward voltages in a circuit with on resistor for the complete circuit causes different forward currents for each LED. This may lead to a variation in brightness. In the worst case, some LED may be subjected to the stresses in excesses of the absolute maximum rating. To avoid brightness variation of LEDs, the use of matrix circuit with one resistor for each LED is recommended.



Pic.1 Recommended Circuit in parallel mode
: Separate resistor must be used in each LED



Pic.2. Abnormal Circuit
The Current through the LEDs may vary due to the variation in forward voltage (V_F) of the LEDs.

- LED should be operated in forward bias. A driving Circuit must be designed so that the LED is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the LED, such operation can cause migration resulting in LED damage.
- If reverse voltage is applied to the LEDs, it will damage the Zener diode and LEDs and result in destruction.

10-8. Application limits of LED Driver IC controller

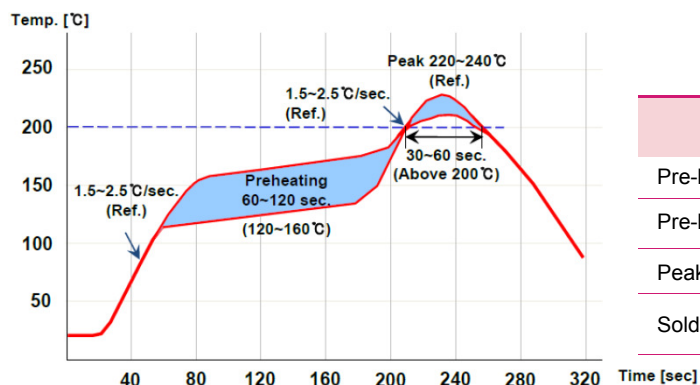
- GaN based LED is relatively weak to electrical damage (such as static electricity and over current stress). Forward leakage of LED occurred by such damage in the forward low current region may result in turn-on-delay of Lighting Module, which is dependent on a specific function of driver IC.
- For reasons mentioned above, minimum current level (source start-up current) of LED driver IC must be more than 0.3 mA. LGIT cannot make a guarantee on the LED using in Driver IC with start up current level of < 0.3 mA.
- When parallel circuit LED driver IC is applied in Lighting Module, Hot spot may occur in low current operation region (dimming mode) by difference of LED voltage in low current region. So, driver IC with Individual LED controller is recommended.

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10-9. Soldering Conditions.

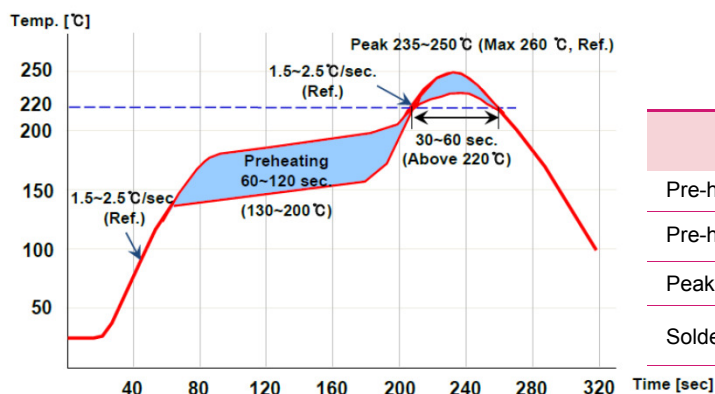
- The LEDs can be soldered in place using the reflow soldering method.
- LG Innotek cannot make a guarantee on the LEDs after they have been assembled using dip soldering method.
- Recommended soldering conditions
- Pb Solder



Lead Free Solder

Pre-heat	150~200 °C
Pre-heat time	120 sec. Max.
Peak-Temperature	260 °C Max
Soldering time Condition	10 sec. Max

- Pb-free Solder



Lead Free Solder

Pre-heat	150~200 °C
Pre-heat time	120 sec. Max.
Peak-Temperature	260 °C Max
Soldering time Condition	10 sec. Max

- Although the recommended soldering conditions are specified in the above diagram, reflow or hand soldering at the lowest possible temperature is desirable for the LEDs.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Occasionally there is a brightness decrease caused by the influence of heat of ambient atmosphere during air reflow. It is recommended that the customer use the nitrogen reflow method.
- The encapsulated material of the LEDs is silicone, Therefore the LEDs have a soft surface on the top of the package. The pressure to the surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So When using the chip mounter, the picking up nozzle that does not affect the silicone resin should be used.
- Reflow soldering should not be done more than two times.

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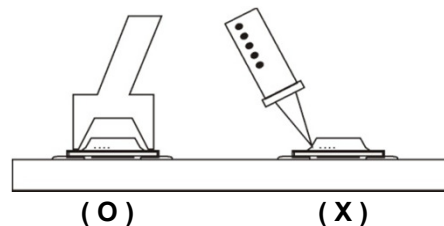
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10-10. Soldering Iron

- Basic spec is $\leq 5\text{sec}$ when 260°C .
- If temperature is higher, time shorter ($+10^\circ\text{C} \rightarrow -1\text{sec}$).
- Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C .

10-11. Repair

- Repairing should not be done after the LEDs have been soldered.
- When repairing is unavoidable, a double-head soldering iron should be used.
- It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- When Soldering, do not put stress on the LEDs during heating customer must finish rework within 5sec. under 245°C .
- The head of Iron can not touch copper foil.
- Twin-head type is preferred.



10-12. Safety Guideline for Human Eyes.

- Users should be cautioned not to stare at the light of this LED product.
- Great care should be taken when viewing directly the LED driven at high current or the LED with optical instruments, which may greatly increase the hazard to your eyes.

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11. Others

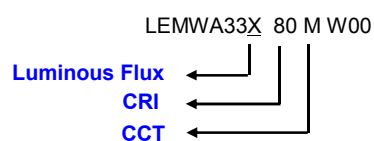
- LG Innotek will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit if use to exceed the absolute maximum ratings, or not keep the matters that demand special attention.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment.
- Consult LG Innotek, sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs, may directly jeopardize life or health.
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from LG Innotek. When defective LEDs are found, The customer shall inform LG Innotek disassembling or analysis.
- The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- The appearance and specification of the product may be modified for improvement without notice

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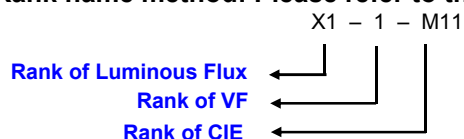
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12. Appendix

※ Model name method: Please refer to the following example Model Name



※ Rank name method: Please refer to the following example Rank Name



▪ Performance Groups of Voltage(@350mA)

Rank	V _F (V, @ 350mA)		
	Min	Typ	Max
0	2.9	-	3.0
1	3.0	-	3.1
2	3.1	-	3.2

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▪ Performance Groups of Brightness(@350mA)

Color	CCT	CCT(K)	Min. Luminous Flux (lm)		Order Code
	Rank		Group	Flux (lm)	
Cool White	F	6,500K	X3	114	LEMWA33X70FWX3
			X4	122	LEMWA33X70FWX4
			X5	130	LEMWA33X70FWX5
			X6	139	LEMWA33X70FWX6
	G	5,700K	X3	114	LEMWA33X70GWX3
			X4	122	LEMWA33X70GWX4
			X5	130	LEMWA33X70GWX5
			X6	139	LEMWA33X70GWX6
	F	6,500K	X3	114	LEMWA33X75FWX3
			X4	122	LEMWA33X75FWX4
			X5	130	LEMWA33X75FWX5
			X6	139	LEMWA33X75FWX6
	G	5,700K	X3	114	LEMWA33X75GWX3
			X4	122	LEMWA33X75GWX4
			X5	130	LEMWA33X75GWX5
			X6	139	LEMWA33X75GWX6
	H	5,000K	X3	114	LEMWA33X75HWX3
			X4	122	LEMWA33X75HWX4
			X5	130	LEMWA33X75HWX5
			X6	139	LEMWA33X75HWX6
Neutral White	J	4,000K	X1	114	LEMWA33X80JWX1
			X2	122	LEMWA33X80JWX2
			X3	130	LEMWA33X80JWX3
			X4	139	LEMWA33X80JWX4
Warm White	K	3500K	W2	87	LEMWA33X80KWW2
			W3	94	LEMWA33X80KWW3
			X1	100	LEMWA33X80KWX1
			X2	107	LEMWA33X80KWX2
	L	3,000K	W2	87	LEMWA33X80LWW2
			W3	94	LEMWA33X80LWW3
			X1	100	LEMWA33X80LWX1
			X2	107	LEMWA33X80LWX2
	M	2,700K	W2	87	LEMWA33X80MWW2
			W3	97	LEMWA33X80MWW3
			X1	100	LEMWA33X80MWX1
			X2	107	LEMWA33X80MWX2

Notes :

- LGIT maintains a tolerance of $\pm 10\%$ on flux and power measurements
- Minimum CRI for F,G,-Rank is available at each 70 and 75.
- Minimum CRI for J,K,L,M-Rank is 80.